



## Titan 210 MX8M

Fanless embedded computer based on NXP i.MX 8M Applications Processors

### Multicore processing and flexible connectivity for multimedia and industrial IoT applications



#### HIGHLIGHTS



**CPU**  
NXP i.MX 8M Family



**GRAPHICS**  
Vivante GC7000Lite GPU



#### CONNECTIVITY

1x GbE; 1x USB3.0; 2x USB2.0; 1x RS-232; Optional on-board WiFi+BLTE; Optional WWAN add-on module



**MEMORY**  
Up to 2GB DDR3L on-board memory



Linux Android

HDMI®  
HIGH-DEFINITION MULTIMEDIA INTERFACE

#### MAIN FIELDS OF APPLICATION



Medical



Industrial  
Automation

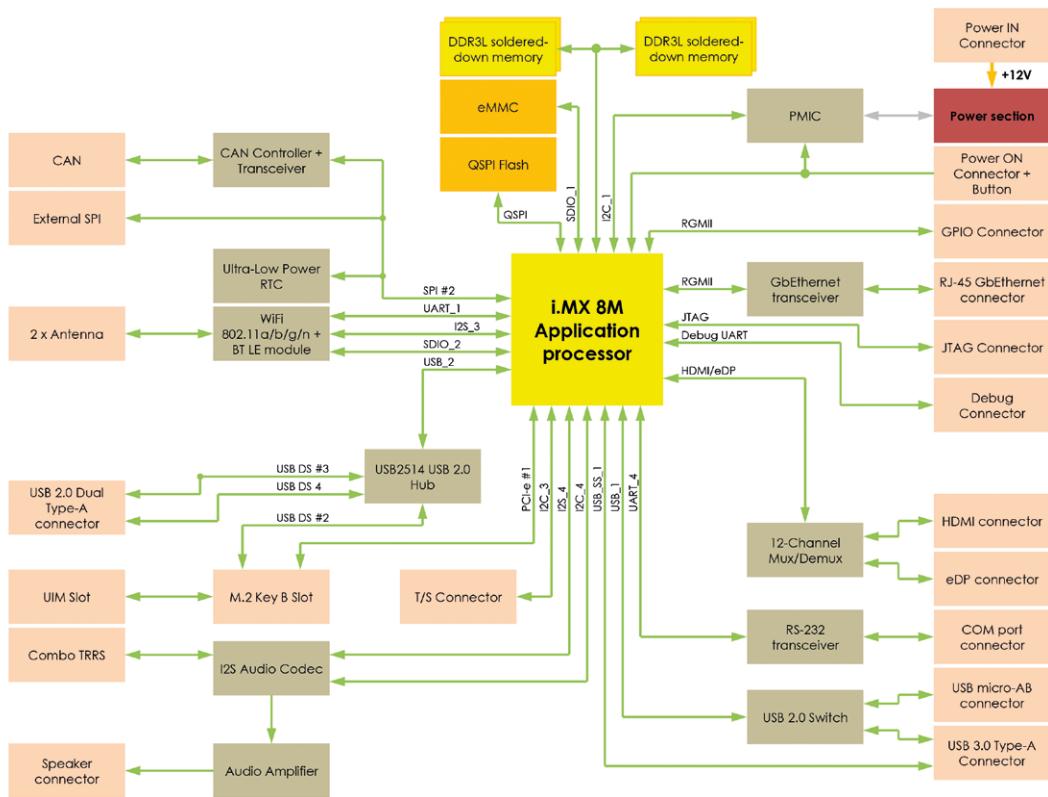


Digital Signage

#### FEATURES

	i.MX 8M Quad, Quad A53-core up to 1.5GHz, with GPU and VPU i.MX 8M QuadLite, Quad A53-core up to 1.5GHz, with GPU only i.MX 8M Dual, Dual A53-core up to 1.5GHz, with GPU and VPU		Line Out + Mic In combo TRRS audio jack Optional Speaker connector, 10W per channel amplified
	32-bit soldered down DDR3L memory, up to 2GB		Optional 2x 12 poles terminal block connectors with the following I/O: · 1x CAN · 8x GPIOs · 1x SPI · 1x I2C · 1x 5V · 1x 3.3V · 1x 12V · 3x GND
	Vivante GC7000Lite GPU, supporting OpenGL ES 1.1 / 2.0 / 3.0 / 3.1, Open CL 1.2 and Vulkan Dedicated VPU (not for QuadLite), supporting 4Kp60 HEVC/H.265 main and main 10 decoder, 4Kp60 VP9 decoder, 4Kp30 AVC/H.264 decoder, 1080p60 MPEG-2, MPEG-4p2, VC-1, VP8, RV9, AVS, MJPEG, H.263 decoder		Power ON Button with integrated LED microSIM slot soldered on-board for the Modem Coin cell battery holder for RTC Optional 4x SMA connectors for external WiFi / WWAN antennas
	Optional HDMI® 1.4 / 2.0a interface		Optional VESA 100 bracket accessory Optional DIN standard mounting plate accessory
	Up to 4K		+12V <sub>dc</sub> Mini-Fit Power connector
	Optional eMMC 5.0 drive on-board, up to 16GB		Linux Android (planned)
	1x Gigabit Ethernet RJ45 connector Optional on-board WiFi (802.11 ac / a / b / g / n) +BT 5.0 module, external antennas* M.2 Socket 2 Key B Slot for optional accessory M.2 Modem, external antennas*		0°C ÷ +50°C 181 x 109 x 75 mm
*Certification upon request		*Measured at any point of the heatspreader/heatsink during any and all times (including start-up). Actual temperature will widely depend on application, enclosure and/or environment. Upon customer to consider specific cooling solutions for the final system to keep the heatspreader temperature in the range indicated.	
	2 x USB 2.0 on Dual Type-A socket 1 x USB 3.0 Type-A socket 1 x USB 2.0 micro-AB connector (interface shared with USB 3.0 port)		
	1 x RS-232 Serial port on DB9-M connector		

## BLOCK DIAGRAM



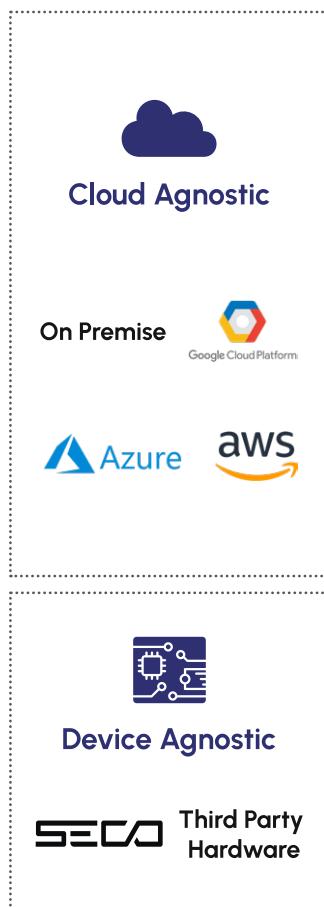
# Streamline and expedite your edge computing implementations

## EDGEHOG OS

A flexible operating system that adapts to your needs, thanks to the customization tool and Docker support. Reliability and security are built-in through a dual-partition system and native integration with Exein's robust AI-based protection.

## DATA ORCHESTRATION

Integrate third-party services, simplify data flows and analysis, and enhance business efficiency by enabling easy and fast utilization of AI.



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our solution

## DEVICE MANAGER

Update, configure, and manage remote devices. Optimize time and costs to maximize operational efficiency and security without the need for costly field interventions.

## PORTAL

Analyze data from remote devices, customize the user experience with applications tailored to user needs, and manage user rights, company access, and tenant privileges.

## SERVICES

Custom Apps



Device Manager

»Edgehog

Data Orchestration

»Astarte

Portal

## EDGEHOG OS

Containers

SDK



Double Partition

Device Manager Agent

Incremental Updates

Immutable OS



EDGEHOG OS

CLEA DOCS

